

L57: (2) 6611047.URPN.
 L58: (30503) (leadframe or (lead adj frame)) and (mar
 L59: (18540) 58 and ((leadframe or (lead adj frame))
 L60: (2368) 59 and ((leadframe or (lead adj frame)) w
 L61: (2368) 60 and (((leadframe or (lead adj frame))
 L62: (2348) 61 not (27 28 38 32 33 34 35 44 45 46 47
 L63: (1139) 62 and (chip or die or "IC")
 L64: (163) 63 and (remov\$4 and etch\$4)
 L65: (143) 64 and (package or shield\$4 or resin)
 L66: (133) 65 and (electrode or pad or terminal)
 L67: (63) 66 and (((leadframe or (lead adj frame)) wi
 L68: (49) 67 and (((leadframe or (lead adj frame)) wi
 L69: (510) 27 28 38 32 33 34 35 44 45 46 47 48 49 50
 L70: (70) 66 not 67
 L71: (70) 70 not 69
 L72: (30) 64 not 66

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 DB: USPAT-US-PGPUB-EPO-JPO-IBM-TDB Exact
 Default operator: OR Highlight all hit terms initially
 67 and (((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4
 or creat\$4 or fabricat\$4))).clm.

U	I	PT	P	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	R	Inventor	S	C
1				US 20040108	20040108	10	Lead-frame-based semiconductor package and fabrication method thereof	257/676	257/787; 438/123; 438/124		Chen, Holman et al.	<input type="checkbox"/>	<input type="checkbox"/>
2				US 20030153129	20030814	9	Method for fabricating preplated nickel/palladium and tin leadframes	438/123			Abbott, Donald C.	<input type="checkbox"/>	<input type="checkbox"/>
3				US 20030151120	20030814	19	Lead-frame forming for improved thermal performance	257/666			Hundt, Michael J. et al.	<input type="checkbox"/>	<input type="checkbox"/>
4				US 20030141577	20030731	15	Short-prevented lead frame and method for fabricating semiconductor package with the	257/676	257/670; 257/787		Hung, Jui-Hsiang et al.	<input type="checkbox"/>	<input type="checkbox"/>
5				US 20030127713	20030710	19	Methods of fabricating multilevel leadframes and semiconductor devices	257/666	257/E23.039		Schoenfeld, Aaron	<input type="checkbox"/>	<input type="checkbox"/>
6				US 20030116833	20030626	11	Lead-frame strip and method of manufacturing semiconductor packages using the same	257/666			Lee, Sang-kyun et al.	<input type="checkbox"/>	<input type="checkbox"/>
7				US 20030092216	20030515	10	METHOD OF MANUFACTURING A SEMICONDUCTOR PACKAGE WITH A LEAD FRAME HAVING A SUPPORT STRUCTURE	438/106			Lee, Meng-Tsang et al.	<input type="checkbox"/>	<input type="checkbox"/>
8				US 20030090877	20030515	25	Lead frame, resin sealing mold and method for manufacturing a semiconductor device using the	361/723	361/690		Ochiai, Isao et al.	<input type="checkbox"/>	<input type="checkbox"/>
9				US 20030501	20030501	16	Lead frame, method of manufacturing a lead frame, resin sealing mold and method for manufacturing a semiconductor device using the	438/123	438/111		Vaschoren	<input type="checkbox"/>	<input type="checkbox"/>

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L Number	Hits	Search Text	DB	Time stamp
27	1	"6650012"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:47
28	302	takahashi-yoshiharu.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:47
29	6	takahashi-yoshiharu.in. and (leadframe and (die or chip or "IC"))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:47
30	38	takahashi-yoshiharu.in. and (lead adj frame and (die or chip or "IC"))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:47
31	41	(takahashi-yoshiharu.in. and (leadframe and (die or chip or "IC")))) (takahashi-yoshiharu.in. and (lead adj frame and (die or chip or "IC"))))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:47
36	0	6650012.URPN.	USPAT	2004/03/23 17:47
37	0	6650012.URPN.	USPAT	2004/03/23 17:47
38	86	((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:47
39	84	((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:48
40	81	((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.) and (method or process)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:48
41	67	((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.) and (method or process), and (package or shield\$4 or resin)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:48
42	64	((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.) and (method or process), and (package or shield\$4 or resin)) and (electrode or terminal or pad)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:49

43	60	<p>(((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:49
52	58	<p>((3838984" "4054238" "4530152" "4707724" "4756080" "4812896" "5029386" "5041902" "5157480" "5172213" "5172214" "5200362" "5200809" "5214845" "5216278" "5221642" "5258094" "5273938" "5277972" "5278446" "5279029" "5332864" "5336931" "5343076" "5406124" "5410180" "5424576" "5435057" "5474958" "5521429" "5604376" "5608267" "5639990" "5640047" "5641997" "5646831" "5650663" "5683806" "5696666" "5701034" "5710064" "5736432" "5776798" "5783861" "5835988" "5859471" "5866939" "5877043" "5886398" "5894108" "5977613" "5977630" "5981314" "5986885" "6001671" "6025640" "6072228" "6130115" "6130473" "6140154" "6143981" "6184465" "6198171" "6225146" "6229200" "6242281" "6281568" "6294100" "6444499" "6464121" "6563209").PN.) and ((lead adj frame) or (leadframe))</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50
53	57	<p>((3838984" "4054238" "4530152" "4707724" "4756080" "4812896" "5029386" "5041902" "5157480" "5172213" "5172214" "5200362" "5200809" "5214845" "5216278" "5221642" "5258094" "5273938" "5277972" "5278446" "5279029" "5332864" "5336931" "5343076" "5406124" "5410180" "5424576" "5435057" "5474958" "5521429" "5604376" "5608267" "5639990" "5640047" "5641997" "5646831" "5650663" "5683806" "5696666" "5701034" "5710064" "5736432" "5776798" "5783861" "5835988" "5859471" "5866939" "5877043" "5886398" "5894108" "5977613" "5977630" "5981314" "5986885" "6001671" "6025640" "6072228" "6130115" "6130473" "6140154" "6143981" "6184465" "6198171" "6225146" "6229200" "6242281" "6281568" "6294100" "6444499" "6464121" "6563209").PN.) and ((lead adj frame) or (leadframe))) and (package or shield\$4 or resin)</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50

54	51	(((("3838984" "4054238" "4530152" "4707724" "4756080" "4812896" "5029386" "5041902" "5157480" "5172213" "5172214" "5200362" "5200809" "5214845" "5216278" "5221642" "5258094" "5273938" "5277972" "5278446" "5279029" "5332864" "5336931" "5343076" "5406124" "5410180" "5424576" "5435057" "5474958" "5521429" "55604376" "5608267" "5639990" "5640047" "5641997" "5646831" "5650663" "5683806" "5696666" "5701034" "5710064" "5736432" "5776798" "5783861" "5835988" "5859471" "5866939" "5877043" "5886398" "5894108" "5977613" "5977630" "5981314" "5986885" "6001671" "6025640" "6072228" "6130115" "6130473" "6140154" "6143981" "6184465" "6198171" "6225146" "6229200" "6242281" "6281568" "6294100" "6444499" "6464121" "6563209").PN.) and ((lead adj frame) or (leadframe))) and (package or shield\$4 or resin)) and (electrode or terminal or pad)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50
32	2	((takahashi-yoshiharu.in. and (leadframe and (die or chip or "IC")))) (takahashi-yoshiharu.in. and (lead adj frame and (die or chip or "IC")))) and (thin adj portion) and (thick adj portion)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50
33	5	("5389816" "5723903" "6081029" "6087201" "6166430").PN.	USPAT	2004/03/23 17:50
34	7	("5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.	USPAT	2004/03/23 17:50
35	13	6166430.URPN.	USPAT	2004/03/23 17:50
44	14	(((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ((("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((("5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) and ((lead adj frame) or (leadframe)).ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50

45	46	((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) not ((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) and ((lead adj frame) or (leadframe)).ti.)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50
46	14	(((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) not ((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) not ((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:50
47	28	("2632693" "2716268" "2757443" "2958120" "3039177" "3148098" "3389461" "3678577" "3923566" "3990142" "4090293" "4363930" "4396457" "4651417" "4867839" "4912844" "5004521" "5100498" "5148265" "5148266" "5194698" "5426850" "5430614" "5489749" "5491302" "5518964" "5629239" "5664325").PN.	USPAT	2004/03/23 17:50
48	2	6083837.URPN.	USPAT	2004/03/23 17:50
49	2	("5648682" "6691241").PN.	USPAT	2004/03/23 17:50
50	1	6563209.URPN.	USPAT	2004/03/23 17:50

51	71	("3838984" "4054238" "4530152" "4707724" "4756080" "4812896" "5029386" "5041902" "5157480" "5172213" "5172214" "5200362" "5200809" "5214845" "5216278" "5221642" "5258094" "5273938" "5277972" "5278446" "5279029" "5332864" "5336931" "5343076" "5406124" "5410180" "5424576" "5435057" "5474958" "5521429" "5604376" "5608267" "5639990" "5640047" "5641997" "5646831" "5650663" "5683806" "5696666" "5701034" "5710064" "5736432" "5776798" "5783861" "5835988" "5859471" "5866939" "5877043" "5886398" "5894108" "5977613" "5977630" "5981314" "5986885" "6001671" "6025640" "6072228" "6130115" "6130473" "6140154" "6143981" "6184465" "6198171" "6225146" "6229200" "6242281" "6281568" "6294100" "6444499" "6464121" "6563209").PN.	USPAT	2004/03/23 17:51
55	2	((("3838984" "4054238" "4530152" "4707724" "4756080" "4812896" "5029386" "5041902" "5157480" "5172213" "5172214" "5200362" "5200809" "5214845" "5216278" "5221642" "5258094" "5273938" "5277972" "5278446" "5279029" "5332864" "5336931" "5343076" "5406124" "5410180" "5424576" "5435057" "5474958" "5521429" "5604376" "5608267" "5639990" "5640047" "5641997" "5646831" "5650663" "5683806" "5696666" "5701034" "5710064" "5736432" "5776798" "5783861" "5835988" "5859471" "5866939" "5877043" "5886398" "5894108" "5977613" "5977630" "5981314" "5986885" "6001671" "6025640" "6072228" "6130115" "6130473" "6140154" "6143981" "6184465" "6198171" "6225146" "6229200" "6242281" "6281568" "6294100" "6444499" "6464121" "6563209").PN.) and ((lead adj frame) or (leadframe))) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (thin adj portion) and (thick adj portion)	USPAT; US-PPGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:51

56	15	(((("3838984" "4054238" "4530152" "4707724" "4756080" "4812896" "5029386" "5041902" "5157480" "5172213" "5172214" "5200362" "5200809" "5214845" "5216278" "5221642" "5258094" "5273938" "5277972" "5278446" "5279029" "5332864" "5336931" "5343076" "5406124" "5410180" "5424576" "5435057" "5474958" "5521429" "5604376" "5608267" "5639990" "5640047" "5641997" "5646831" "5650663" "5683806" "5696666" "5701034" "5710064" "5736432" "5776798" "5783861" "5835988" "5859471" "5866939" "5877043" "5886398" "5894108" "5977613" "5977630" "5981314" "5986885" "6001671" "6025640" "6072228" "6130115" "6130473" "6140154" "6143981" "6184465" "6198171" "6225146" "6229200" "6242281" "6281568" "6294100" "6444499" "6464121" "6563209").PN.) and ((lead adj frame) or (leadframe)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (inner adj lead) and support 6611047.URPN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:51
57	2		USPAT	2004/03/23 17:51
58	30503	(leadframe or (lead adj frame)) and (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:52
59	18540	((leadframe or (lead adj frame)) and (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:53
60	2368	((leadframe or (lead adj frame)) and (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:53
61	2368	((((leadframe or (lead adj frame)) and (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.) and (((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.) and (((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:57

Search History 3/23/2017 10:58:33 AM Page 5977613".PN.)
6166430.URPN.)) and (method or process)
C:\APPS\EAST\Workspaaand\1page.wspshield\$4 or resin)))
(("2632693" | "2716268" | "2757443" |

64	163	<p>(((((((leadframe or (lead adj frame)) and (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4))) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.) and (((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.) not ("6650012" takahashi-yoshiharu.in. ((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion) (((takahashi-yoshiharu.in. and (leadframe and (die or chip or "IC"))))</p> <p>(takahashi-yoshiharu.in. and (lead adj frame and (die or chip or "IC")))) and (thin adj portion) and (thick adj portion) ("5389816" "5723903" "6081029" "6087201" "6166430").PN.)</p> <p>((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.</p> <p>(((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) and ((lead adj frame) or (leadframe)).ti.) ((((((lead adj frame) or (leadframe)) and (thin adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) not ((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) and ((lead adj frame) or (leadframe)).ti.) (((((lead adj frame) or (leadframe)) and (thin adj portion)) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) not (((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process))</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 17:56
Search History	3/23/2004 6:17:20 PM C:\APPS\EAST\Workspaaag\1966890.wspshield\$4 or resin))) (("2632693" "2716268" "2757443"			

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3/23 906696 17 | 20 5973388 Page "5977613"). PN.)
6166430.URPN.)) and (method or process)
spaa8\19668990.wspshield\$4 or resin)))
((2632693" | "2716268" | "2757443" |

Search History 3/23/2016 17:20:59 Page 5977613).PN.)
6166430.URPN.)) and (method or process)
C:\APPS\EAST\Workspaaed\1package.wspshield\$4 or resin)))
(("2632693" | "2716268" | "2757443" |

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| "6691241").PN.) 6563209.URPN.

71	70	<p>((((((((leadframe or (lead adj frame)) and (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4))) and ((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.) and (((leadframe or (lead adj frame)) with (manufactur\$4 or form\$4 or creat\$4 or fabricat\$4)).ti.) not ("6650012" takahashi-yoshiharu.in. ((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) (((takahashi-yoshiharu.in. and (leadframe and (die or chip or "IC")))) (takahashi-yoshiharu.in. and (lead adj frame and (die or chip or "IC")))) and (thin adj portion) and (thick adj portion)) ("5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.</p> <p>((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ((5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) and ((lead adj frame) or (leadframe)).ti.) (((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ((5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) not (((((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ((5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)) and (electrode or terminal or pad)) and (plurality)) and ((lead adj frame) or (leadframe)).ti.) (((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ((5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) not (((((lead adj frame) or (leadframe)) and (thin adj portion) and (thick adj portion)) not (takahashi-yoshiharu.in. ((5389816" "5723903" "6081029" "6087201" "6166430").PN.) ((5294827" "5521429" "5841187" "5844307" "5900676" "5973388" "5977613").PN.) 6166430.URPN.)) and (method or process)) and (package or shield\$4 or resin)))</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/23 18:05
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